Vishay Semiconductors

High Speed Infrared Emitting Diodes, 940 nm, GaAIAs, MQW



www.vishay.com

DESCRIPTION

VSMB2948 series are infrared, 940 nm emitting diodes in GaAlAs multi quantum well (MQW) technology with high radiant power and high speed, molded in clear, untinted plastic packages (with lens) for surface mounting (SMD).

APPLICATIONS

- IR touch panels
- Remote control

FEATURES

- Package type: surface mount
- · Package form: GW, RGW
- Dimensions (L x W x H in mm): 2.3 x 2.3 x 2.55
- Peak wavelength: $\lambda_p = 940 \text{ nm}$
- High reliability
- · High radiant power
- · High radiant intensity
- Angle of half intensity: $\varphi = \pm 25^{\circ}$
- · Low forward voltage
- Suitable for high pulse current operation
- · Terminal configurations: gullwing or reserve gullwing
- Package matches with detector VEMD2xx3X01 and VEMT2xx3X01 series
- Floor life: 4 weeks, MSL 2a, according to J-STD-020
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

PRODUCT SUMMARY					
COMPONENT	l _e (mW/sr)	φ (°)	λ _p (nm)	t _r (ns)	
VSMB2948RG	20	± 25	940	15	
VSMB2948G	20	± 25	940	15	

Note

Test conditions see table "Basic Characteristics"

ORDERING INFORMATION				
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM	
VSMB2948RG	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Reverse gullwing	
VSMB2948G	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Gullwing	

Note

• MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Reverse voltage		V _R	5	V	
Forward current		I _F	100	mA	
Surge forward current	t _p = 100 μs	I _{FSM}	500	mA	
Power dissipation		Pv	160	mW	
Junction temperature		Тj	100	°C	
Operating temperature range		T _{amb}	- 40 to + 85	°C	
Storage temperature range		T _{stg}	- 40 to + 100	°C	
Soldering temperature	according figure 9, J-STD-020	T _{sd}	260	°C	
Thermal resistance junction/ambient	J-STD-051, leads 7 mm, soldered on PCB	R _{thJA}	250	K/W	

1 For technical questions, contact: emittertechsupport@vishay.com Document Number: 84201



HALOGEN FREE

GREEN

(5-2008)



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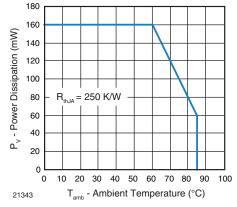


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

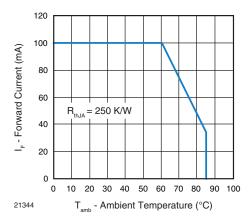


Fig. 2 - Forward Current Limit vs. Ambient Temperature

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
For word wolds and	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	V _F	1.15	1.35	1.6	V
Forward voltage	$I_F = 500 \text{ mA}, t_p = 100 \ \mu \text{s}$	V _F		1.8		V
Temperature coefficient of V_F	I _F = 1 mA	TK _{VF}		- 1.5		mV/K
Reverse current	V _R = 5 V	I _R			10	μA
Junction capacitance	$V_R = 0 V$, f = 1 MHz, E = 0 mW/cm ²	CJ		21		pF
Dedieut intereit :	I _F = 100 mA, t _p = 20 ms	l _e	10	20	30	mW/sr
Radiant intensity	I _F = 500 mA, t _p = 100 μs	l _e		90		mW/sr
Radiant power	I _F = 100 mA, t _p = 20 ms	φ _e		40		mW
Temperature coefficient of radiant power	I _F = 1 mA	TKø _e		- 1.1		%/K
Angle of half intensity		φ		± 25		0
Peak wavelength	I _F = 30 mA	λρ	920	940	960	nm
Spectral bandwidth	I _F = 30 mA	Δλ		25		nm
Temperature coefficient of λ_p	I _F = 30 mA	ΤΚλ _p		0.25		nm/K
Rise time	I_F = 100 mA, 20 % to 80 %	t _r		15		ns
Fall time	I_F = 100 mA, 20 % to 80 %	t _f		15		ns
Cut-off frequency	I _{DC} = 70 mA, I _{AC} = 30 mA pp	f _c		23		MHz



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BASIC CHARACTERISTICS (Tamb = 25 °C, unless otherwise specified)

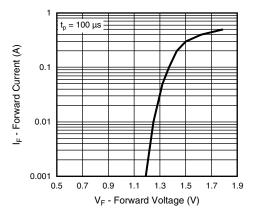


Fig. 3 - Forward Current vs. Forward Voltage

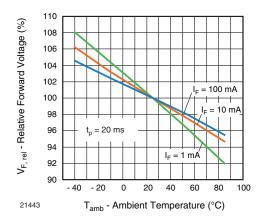


Fig. 4 - Relative Forward Voltage vs. Ambient Temperature

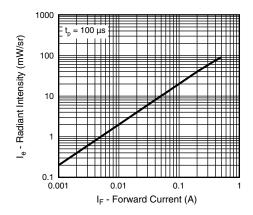


Fig. 5 - Radiant Intensity vs. Forward Current

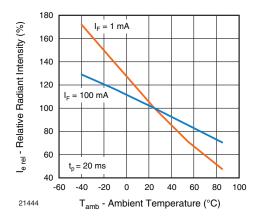


Fig. 6 - Relative Radiant Intensity vs. Ambient Temperature

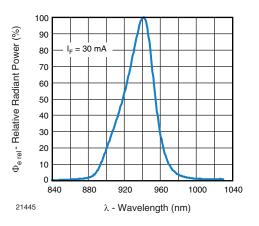


Fig. 7 - Relative Radiant Power vs. Wavelength

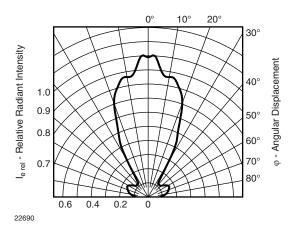


Fig. 8 - Relative Radiant Intensity vs. Angular Displacement

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SOLDER PROFILE

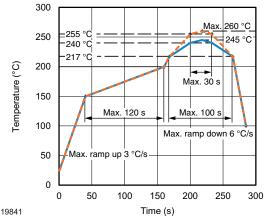


Fig. 9 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020

c

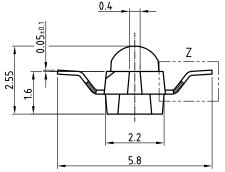
0.75

7

Cathode

m

PACKAGE DIMENSIONS in millimeters: VSMB2948RG



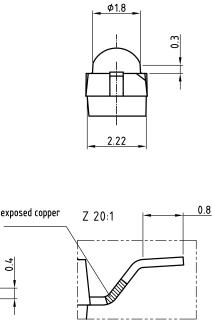
2.3

Pin ID

6.7

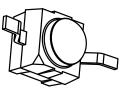
Drawing refers to following types:

Drawing-No.: 6.544-5409.01-4 Issue: prel. 03.08.12





Dimensions in mm Not indicated tolerances ±0.2



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VSMB2943RGX01 VSMF2893RGX01 VEMD2x23X01

Anode

acc. IPC 7351

Ø2<u>.3±0.1</u>

Solder pad proposal

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DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label: Floor life: 4 weeks Conditions: $T_{amb} < 30$ °C, RH < 60 % Moisture sensitivity level 2a, according to J-STD-020.

DRYING

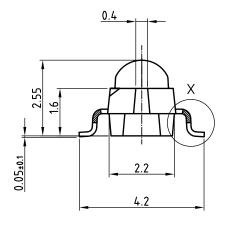
In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.

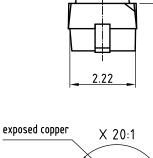


<u>с</u>

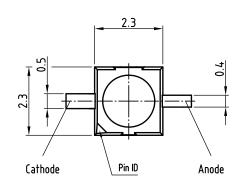
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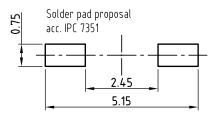
PACKAGE DIMENSIONS in millimeters: VSMB2948G





Ø1.8



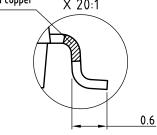


 Drawing refers to following types:
 VSMB2943GX01

 VSMF2893GX01
 VSMF2893GX01

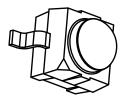
 Drawing-No.: 6.544-5408.01-4
 VEMD2x23X01

 Issue: prel; 03.08.12
 0.08.12





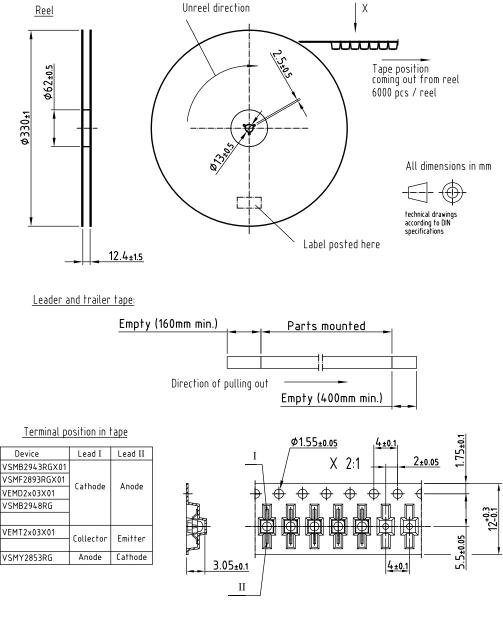
Dimensions in mm Not indicated tolerances ±0.2





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TAPING AND REEL DIMENSIONS in millimeters: VSMB2948RG



Drawing refers to following types: Reel dimensions and tape

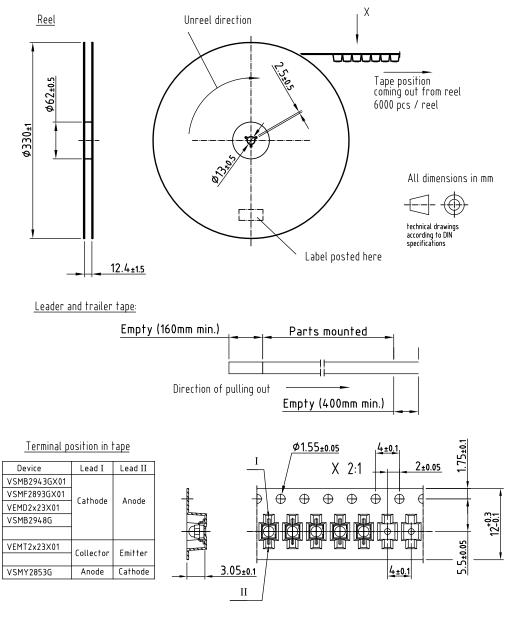
see table

Drawing-No.: 9.800-5100.02-4 Issue: prel; 03.08.12



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TAPING AND REEL DIMENSIONS in millimeters: VSMB2948G



Drawing refers to following types: see table Reel dimensions and tape Drawing-No.: 9.800-5091.21-4 Issue: prel; 03.08.12



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